

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/673,910  
Applicant: Matsuda  
Art Unit: 1762  
Title: **METHOD FOR DEPOSITING METAL LAYERS USING  
SEQUENTIAL FLOW DEPOSITION**  
Docket No. RAJ-007  
Confirmation No.: 7364

May 19, 2008

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT – AFTER FINAL REJECTION**

This paper is responsive to the final Office Action dated February 14, 2008. The Examiner has indicated that claims 1-6, 8-20, 22, 24-26, 28-33, 35-41, 43-55, 57, 59-61, 63-70, and 72 -82 are pending and rejected. The present response includes the following:

Amendments to the Specification:	None
Amendments to the Claims:	None
Amendments to the Abstract:	None
Amendments to the Drawings:	None
Remarks:	Pages 2-3
Attachments:	None